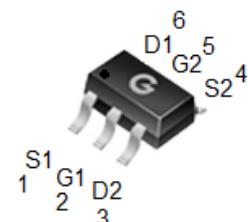
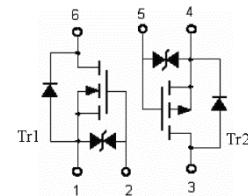


Features

- Low on-resistance
- ESD protected
- High speed switching
- Low leakage current

HF



SOT-363

Mechanical Data

- Case: SOT-363
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BL3439	SOT-363	3000 pcs / Tape & Reel	3439

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Tr1	Tr2	Unit
Drain-to-Source Voltage	V_{DSS}	30	-30	V
Gate-to-Source Voltage	V_{GSS}	± 12	± 12	V
Continuous Drain Current	I_D	0.75	-0.4	A
Pulsed Drain Current *1	I_{DM}	2.2	-1.2	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation ($T_A = 25^\circ\text{C}$)	P_D	0.31	W
Thermal Resistance Junction-to-Air *2	$R_{\theta JA}$	403	°C/W
Operating Junction Temperature Range	T_J	-55 ~ +150	°C
Storage Temperature Range	T_{STG}	-55 ~ +150	°C

Electrical Characteristics-Tr2 (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}$, $I_D = -250\mu\text{A}$	-30	-	-	V
$I_{DS(0)}$	Zero Gate Voltage Drain Current	$V_{DS} = -30\text{V}$, $V_{GS} = 0\text{V}$	-	-	-1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 10\text{V}$, $V_{DS} = 0\text{V}$	-	-	± 10	μA
On Characteristics ^{*3}						
$R_{DS(ON)}$	Static Drain-Source On-resistance	$V_{GS} = -10\text{V}$, $I_D = -0.3\text{A}$	-	-	0.62	Ω
		$V_{GS} = -4.5\text{V}$, $I_D = -0.3\text{A}$	-	-	0.90	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250\mu\text{A}$	-0.55	-	-1.95	V
Dynamic Characteristics ^{*4}						
C_{ISS}	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = -10\text{V}$ $f = 1.0\text{MHz}$	-	120	-	pF
C_{OSS}	Output Capacitance		-	18	-	
C_{RSS}	Reverse Transfer Capacitance		-	9	-	
Switching Characteristics ^{*4}						
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD} = -10\text{V}$ $V_{GS} = -4.5\text{V}$ $R_G = 10\Omega$ $I_D = -0.2\text{A}$	-	9	-	ns
t_r	Turn-on Rise Time		-	6	-	
$t_{d(OFF)}$	Turn-Off Delay Time		-	34	-	
t_f	Turn-Off Fall Time		-	20	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage	$I_{SD} = -0.4\text{A}$, $V_{GS} = 0\text{V}$	-	-	-1.2	V

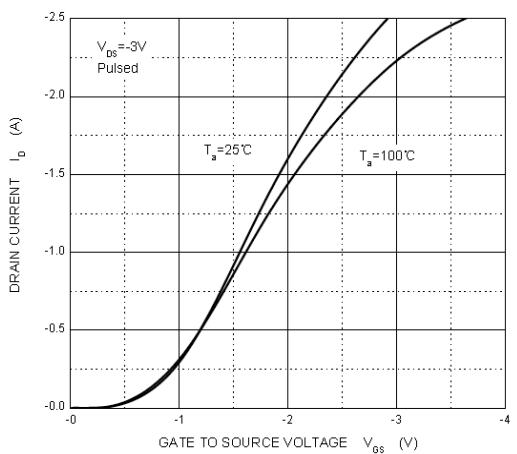
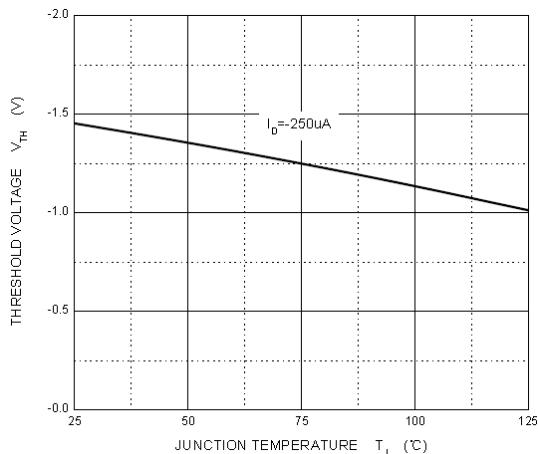
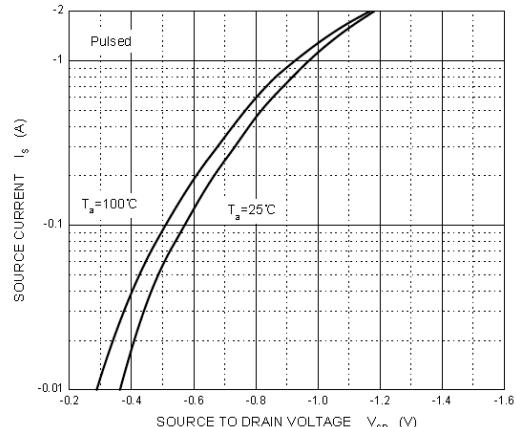
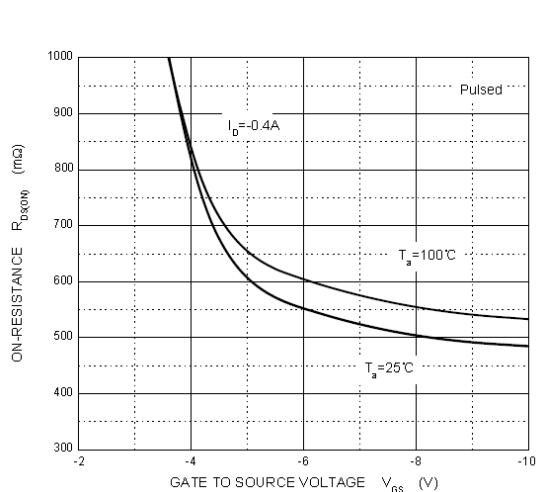
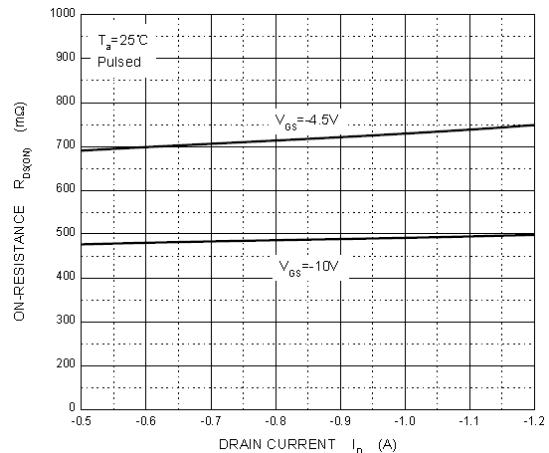
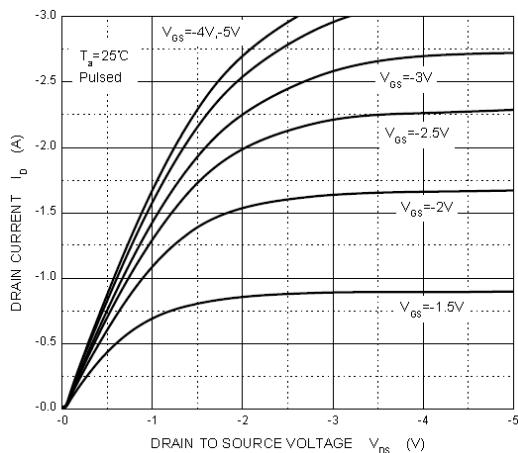
Electrical Characteristics-Tr1 (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	30	-	-	V
$I_{DS(0)}$	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 10V, V_{DS} = 0V$	-	-	± 10	μA
On Characteristics *3						
$R_{DS(ON)}$	Static Drain-Source On-resistance	$V_{GS} = 10V, I_D = 0.6A$	-	-	0.37	Ω
		$V_{GS} = 4.5V, I_D = 0.6A$	-	-	0.42	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.5	-	1.5	V
Dynamic Characteristics						
C_{ISS}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 10V$ $f = 1.0\text{MHz}$	-	44	-	pF
C_{OSS}	Output Capacitance		-	15	-	
C_{RSS}	Reverse Transfer Capacitance		-	8	-	
Switching Characteristics						
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD} = 10V$ $V_{GS} = 4.5V$ $R_G = 51\Omega$ $I_D = 0.7A$	-	5	-	ns
t_r	Turn-on Rise Time		-	8	-	
$t_{d(OFF)}$	Turn-Off Delay Time		-	23	-	
t_f	Turn-Off Fall Time		-	41	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage	$I_{SD} = 0.6A, V_{GS} = 0V$	-	-	1.2	V

Notes:

1. Pulse width limited by maximum junction temperature
2. Surface Mounted on FR4 Board, $t < 5$ sec
3. The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
4. Guaranteed by design, not subject to production testing

Ratings and Characteristics Curves-Tr2 (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)



Ratings and Characteristics Curves-Tr1 (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

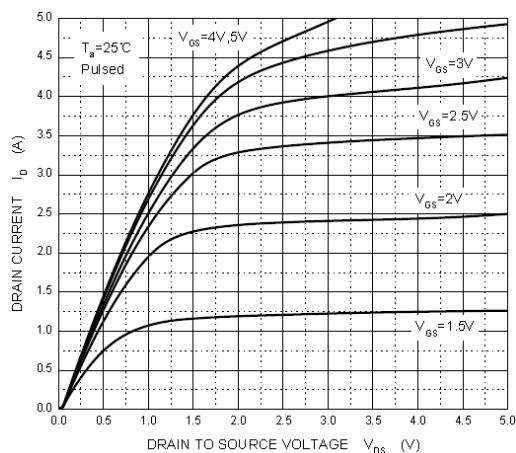


Fig 1 Output Characteristics

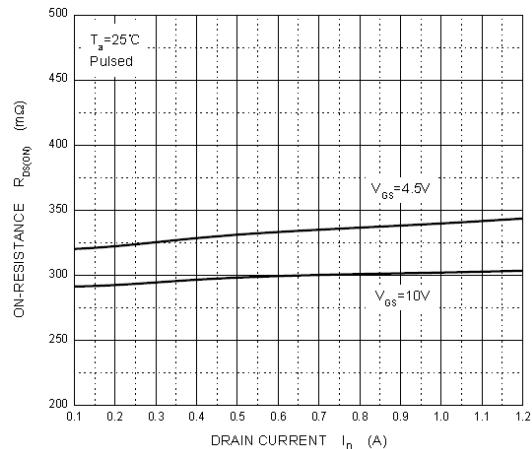


Fig 2 On-Resistance vs. Drain Current
and Gate Voltage

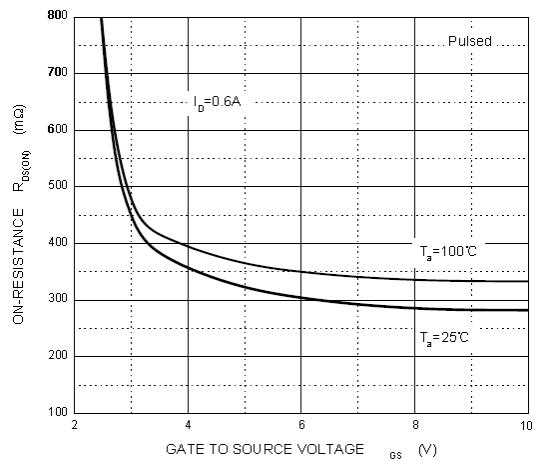


Fig 3 On-Resistance vs. Gate-Source Voltage

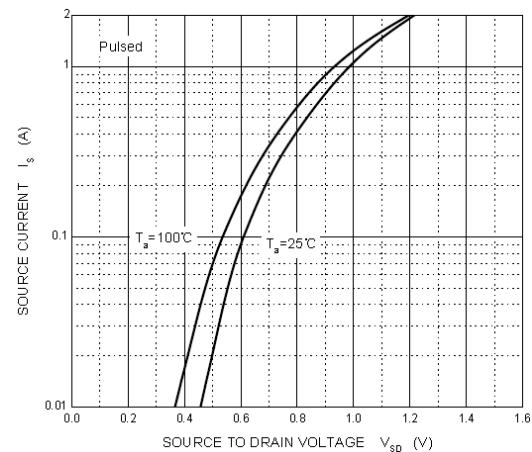


Fig 4 Body-Diode Characteristics

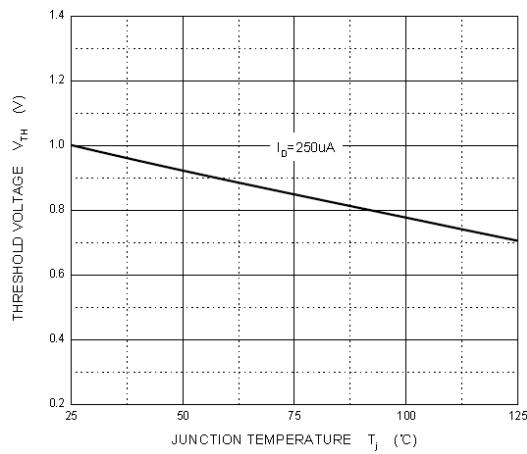


Fig 5 Gate Voltage vs. Junction Temperature

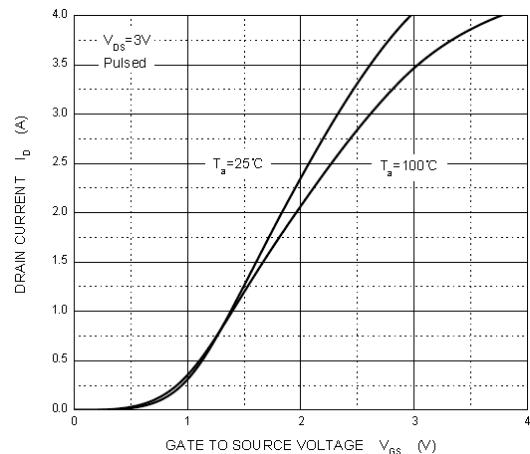
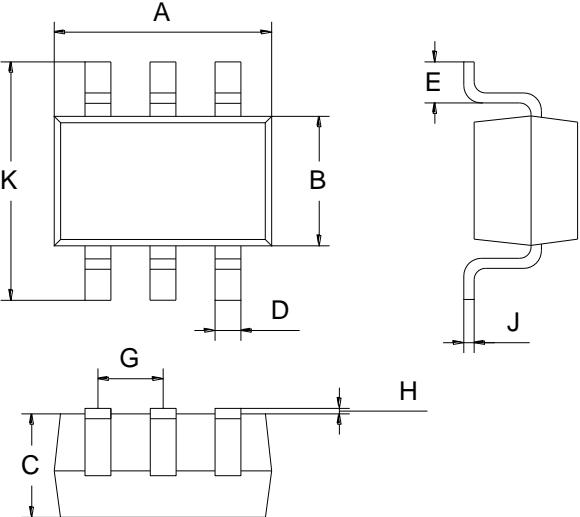


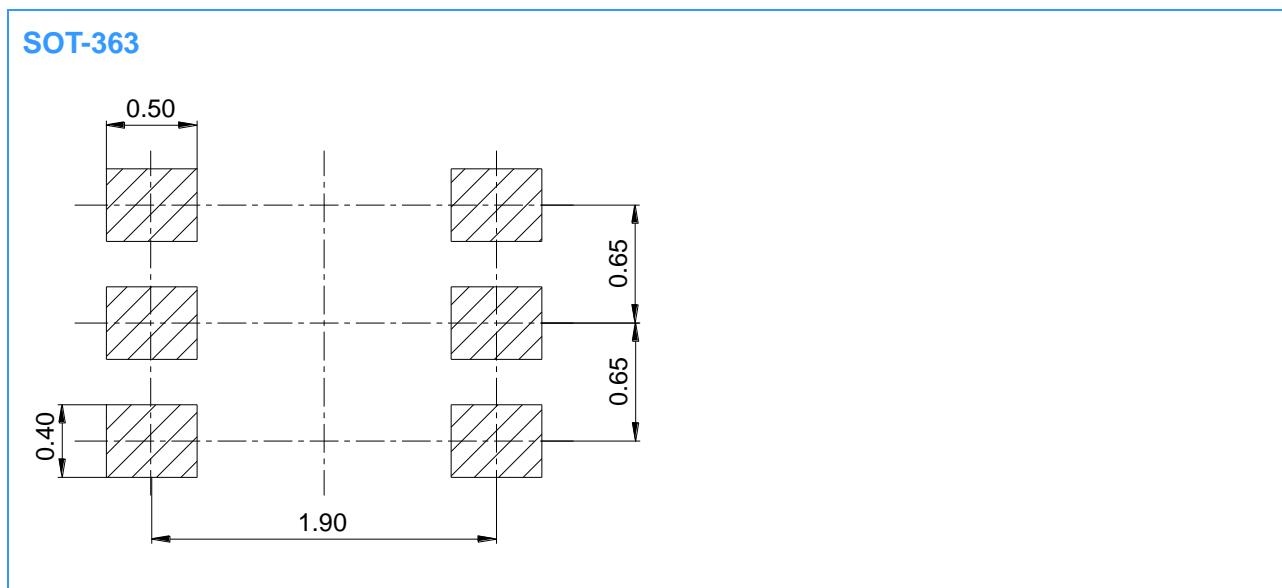
Fig 6 Transfer Characteristics

Package Outline Dimensions (Unit: mm)



SOT-363		
Dimension	Min.	Max.
A	2.00	2.20
B	1.15	1.35
C	0.85	1.05
D	0.15	0.35
E	0.25	0.40
G	0.60	0.70
H	0.02	0.10
J	0.05	0.15
K	2.20	2.40

Mounting Pad Layout (Unit: mm)



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